

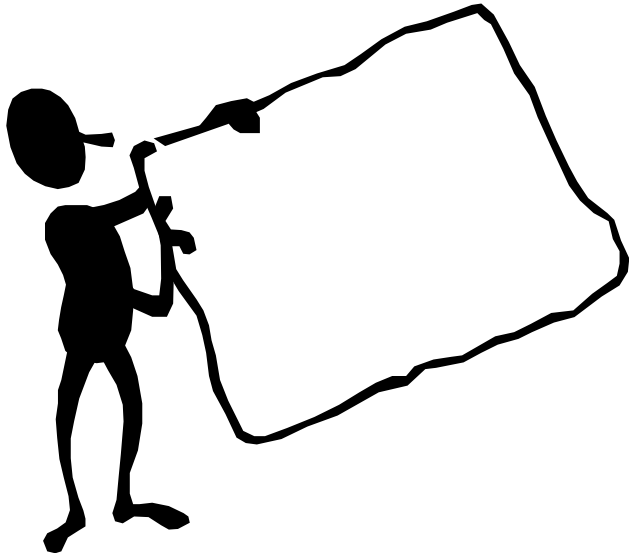
Driving the GSPS ADCs in Single- or Dual-Channel Mode for High Bandwidth Applications

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Outline



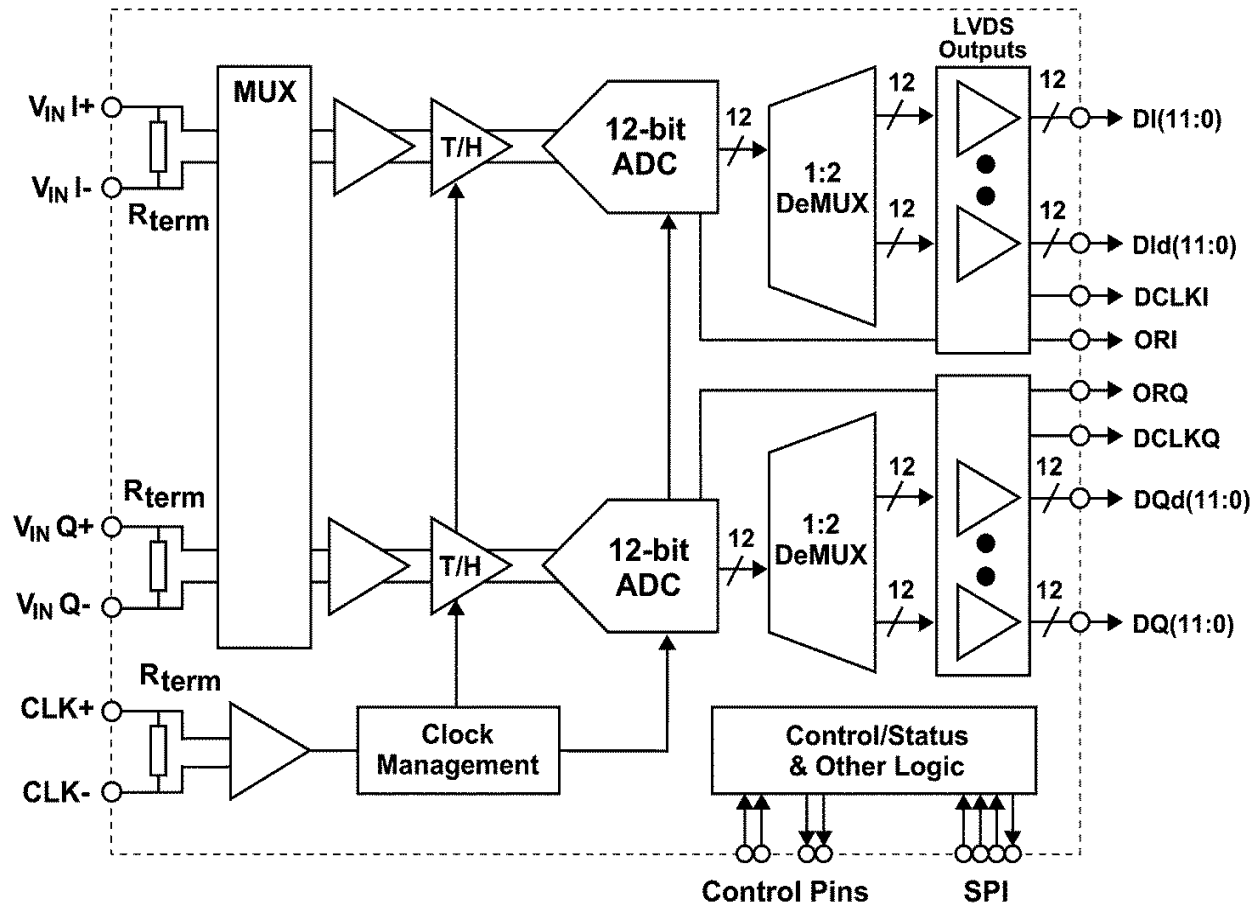
- Overview of the problem
- Solutions evaluation criteria
- Designs tested and key features
- Results summary
- Summary and recommendations

AN OVERVIEW OF THE PROBLEM

Products covered

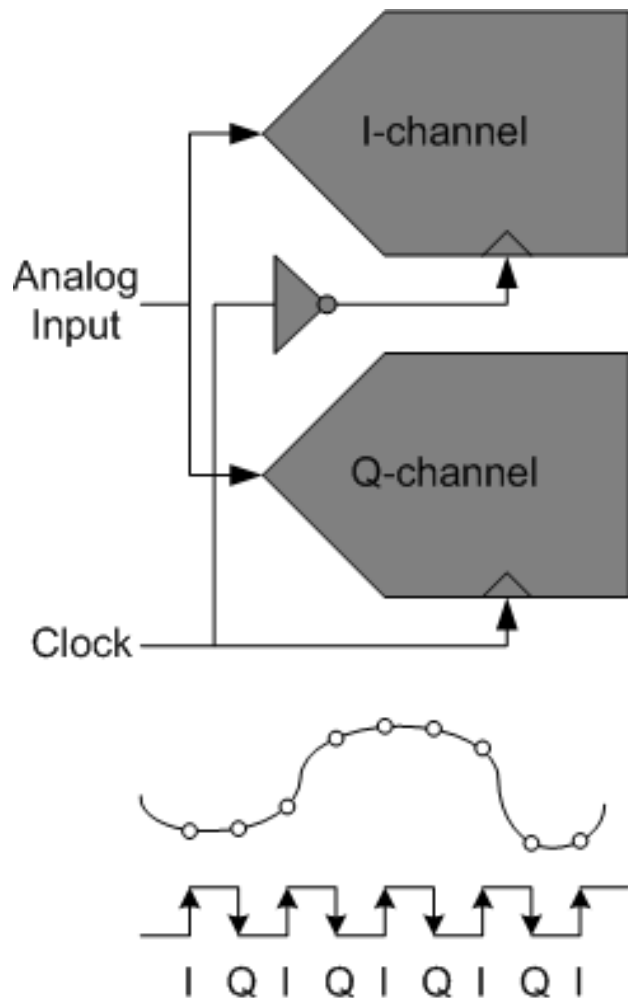
- Which products does the presentation pertain to?
 - ADC12D2000/1800/1600/1000/800/500RF
 - ADC12D1800/1600/1000
 - ADC10D1500/1000
- Actual product evaluated is the ADC12D1600RF

Dual-channel ADCs may be interleaved to achieve 2x sampling rate



There are a number of options for driving the ADC in interleaved mode, which flexibility also presents a design challenge.

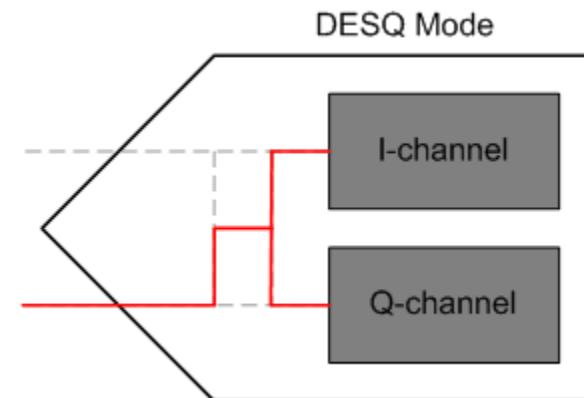
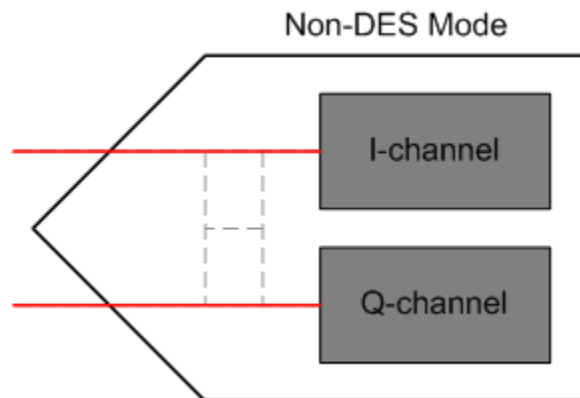
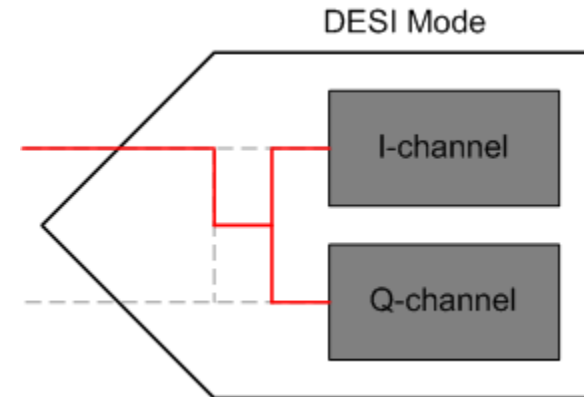
What is DES Mode?



- DES is “Dual-Edge Sampling” Mode.
- This describes how the interleaved mode is clocked.
- One channel samples on the rising edge of the clock while the other channel samples on the falling edge of the clock.
- Both channels sample the same analog input.

What are the various DES Modes?

	Input Driven	Interleaved
Non-DES	I, Q	No
DESI	I	Yes
DESQ	Q	Yes
DESIQ	I and Q	Yes
DESCLKIQ	I and Q	Yes

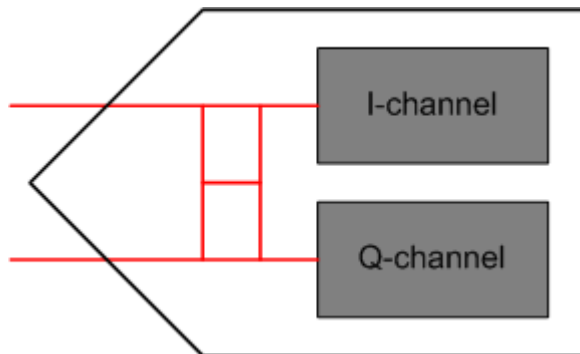


Note: Inputs are differential, e.g. $V_{IN}Q+/-$, but they are represented here as single-ended.

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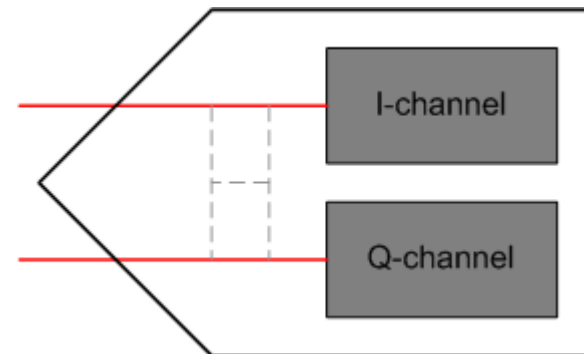
What is the difference between DESIQ and DESCLKIQ Mode?

DESIQ Mode



- Pros
 - Less insertion loss than DESI, DESQ
 - Shorted analog inputs to ensure same signal sampled
- Cons
 - More insertion loss than DESCLKIQ Mode

DESCLKIQ Mode

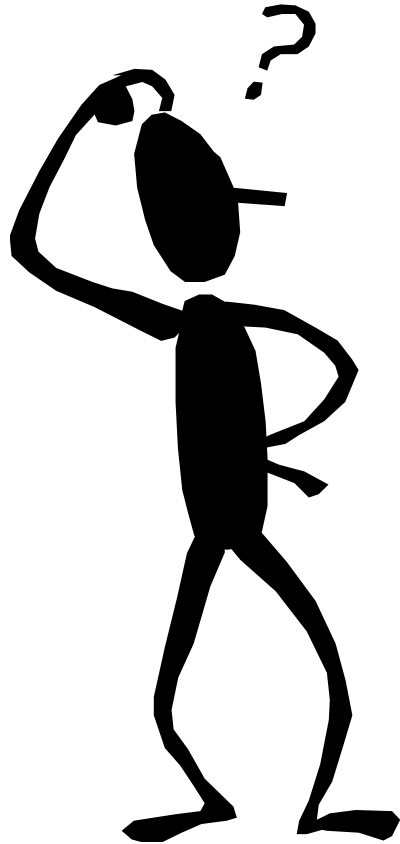


- Pros
 - Minimum insertion loss
- Cons
 - Driving the non-shorter inputs requires careful design to ensure the signal fidelity at each point

Which product has which mode available?

	Non-DES	DESI, DESQ	DESIQ	DESCCLKIQ
ADC12D1800/1600/1000RF	✓	✓	✓	✓
ADC12D800/500RF	✓	✓	✓	✓
ADC12D1800/1600/1000	✓	✓	✓	
ADC10D1500/1000	✓	✓	✓	

Problem statement



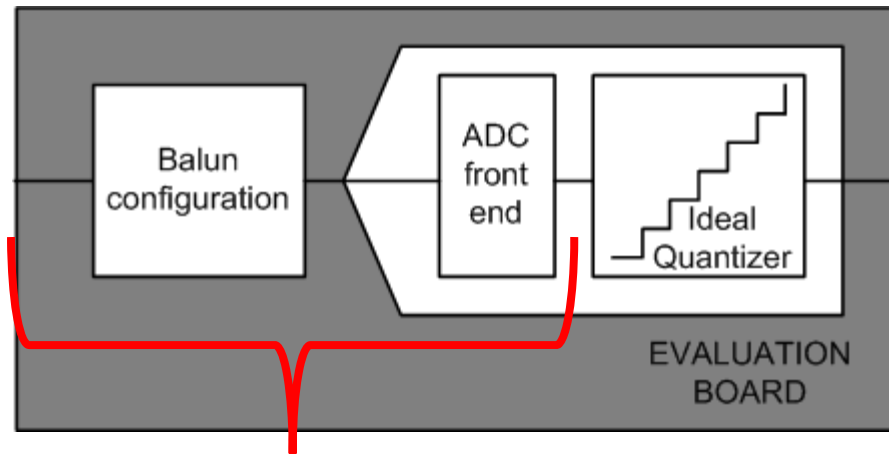
What is a recommended topology, layout, and type of balun to effectively drive each mode?

SOLUTIONS EVALUATION CRITERIA

Dynamic Performance

- Signal-to-Noise Ratio (SNR)
- Spurious Free Dynamic Range (SFDR)
- Total Harmonic Distortion (THD)
- Effective Number of Bits (ENOB)

Insertion Loss

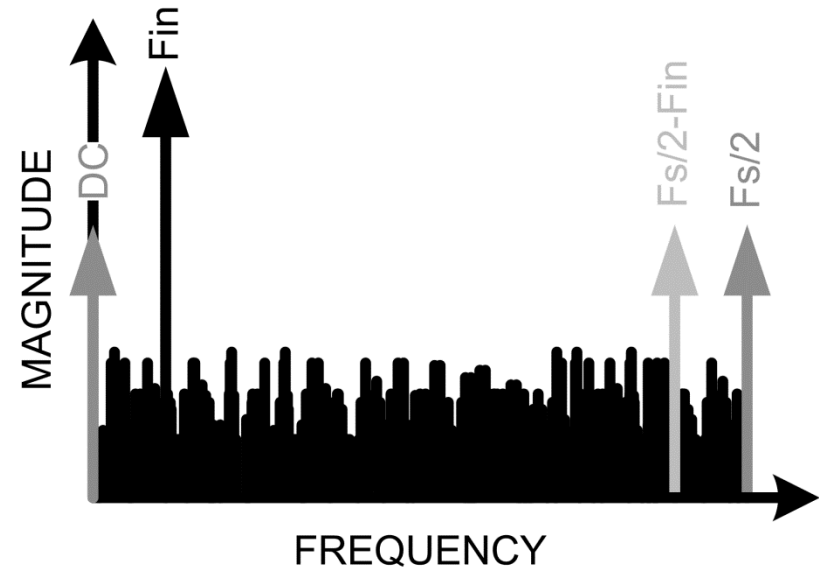


System insertion loss

- The system insertion loss, in dB, includes effects from:
 - Evaluation board
 - Balun configuration
 - ADC front-end

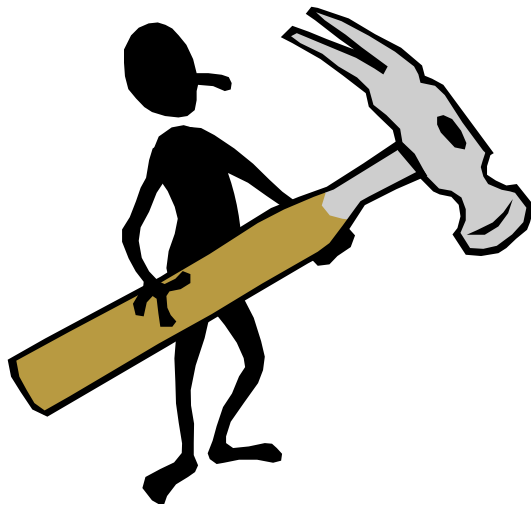
Ability to Minimize DES Timing Spur

- Gain mismatch and timing skew create an interleaving spur, located at $F_s/2 - F_{in}$.
- This spur can be minimized by the Channel Full-Scale Range and DES Timing Adjust features.
- The solution should allow for the magnitude of the interleaving spur to be adjusted below the level of other spurs, so that it is not the SFDR-limiting spur.



Spurious content generated from offset and gain mismatch and timing skew.

Multi-mode applications



- Some applications require the flexibility to configure the ADC into multiple interleaved modes.
- Can the topology accommodate that?

DESIGNS TESTED

Design Planning

Things to Consider

- Topology: I and Q inputs are differential and mirrored
- Input impedance: changes when inputs are driven in parallel
- Balun selection: test a wire-wound and a multi-layer balun

Designs Tested

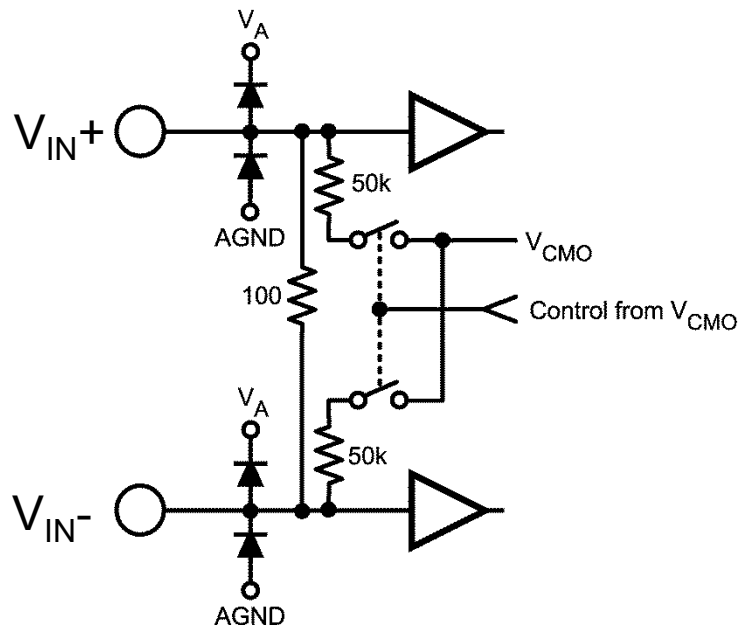
- **Board A**: Multi-layer balun with power splitter to I- and Q-channel input
- **Board B**: Multi-layer balun on I-channel input; wire-wound balun on Q-channel input
- **Board C**: Cascaded Multi-layer balun to I- and Q-channel input
- **Board F**: Wire-wound balun to I- and Q-channel input
- **Board G**: Multi-layer balun to I- and Q-channel input

Topological challenge

G	V_TC	GND_TC	V_TC	V_TC
H	VinI+	V_TC	GND_TC	V_A
J	VinI-	GND_TC	V_TC	VbiasI
K	GND	VbiasI	V_TC	GND_TC
L	GND	VbiasQ	V_TC	GND_TC
M	VinQ-	GND_TC	V_TC	VbiasQ
N	VinQ+	V_TC	GND_TC	V_A
P	V_TC	GND_TC	V_TC	V_TC

- Driving the I- and Q-channels externally at the same time is challenging because I+ and Q+ are not adjacent to one another. (Also, not I- and Q-).
- For a solution which is directly driven, this requires that at least one signal must cross over two of the others. It is challenging to design this layout to be symmetrical.

Impedance Considerations

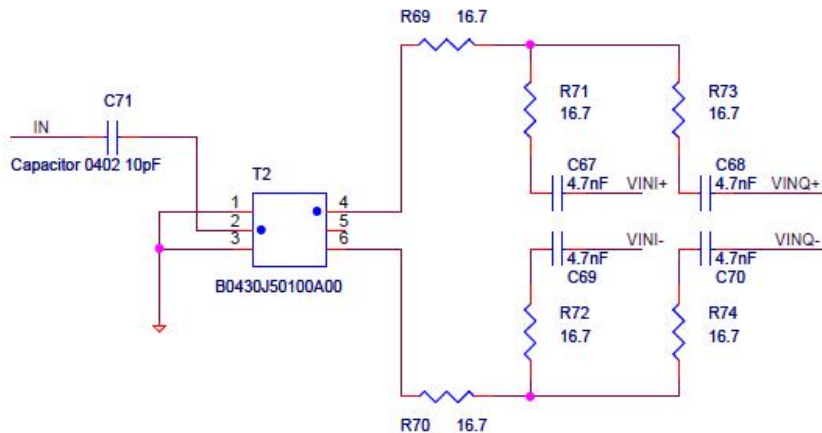
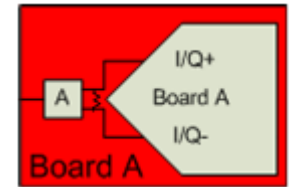


- When driving one I or Q input, the input impedance is 100Ω differential:
 - Non-DES
 - DESI
 - DESQ
- When driving both I and Q inputs, the combined input impedance is 50Ω differential:
 - DESIQ
 - DESCLKIQ

Baluns Evaluated

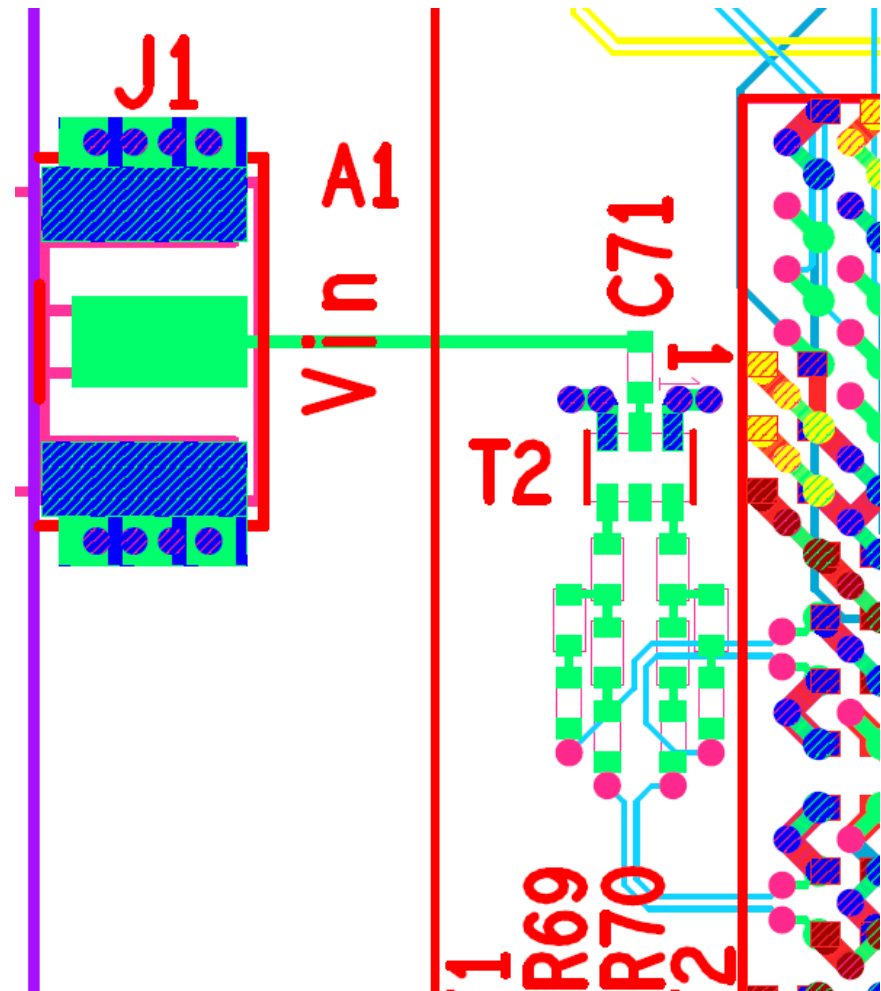
Manufacturer	Anaren	Anaren	Mini-Circuits
Model	B0430J50100	B0322J5050	TC1-1-13MA+
Frequency Range	{400MHz, 3000MHz}	{300MHz, 2200MHz}	{4.5MHz, 3000MHz}
Impedance Ratio	1:2	1:1	1:1
Description	Multi-layer: coupled strip-line with softboard dielectric	Multi-layer: coupled strip-line with softboard dielectric	Wire-wound with ferrite core

Board A: Multi-layer balun with power splitter to I- and Q-channel input

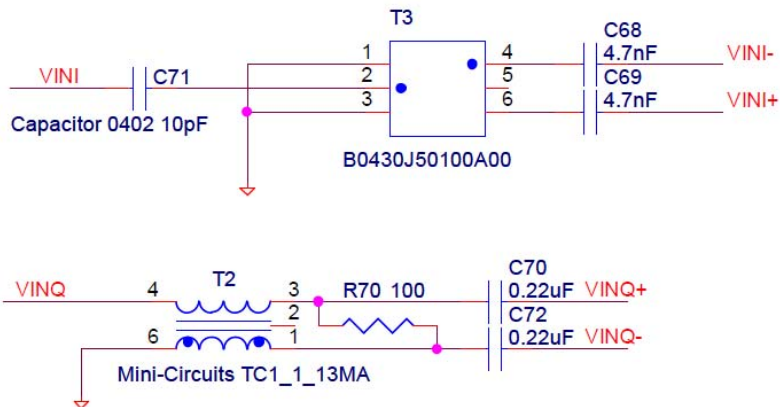
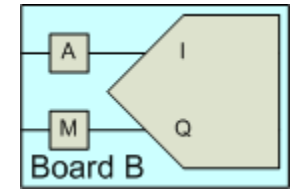


Key Features:

- Testing DESIQ and DESCLKIQ Modes
- Single Multi-layer balun
- Resistors are used to split the power and maintain impedance matching
- Routing in multiple layers

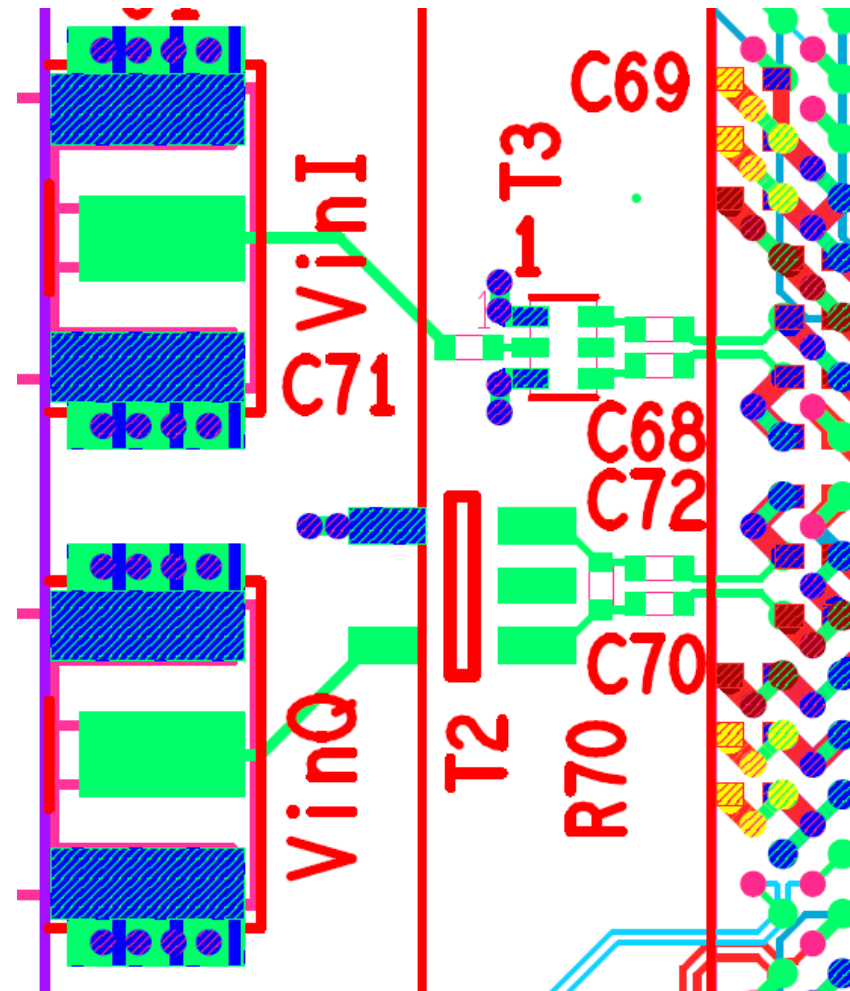


Board B: Multi-layer balun on I-input; wire-wound balun on Q-input

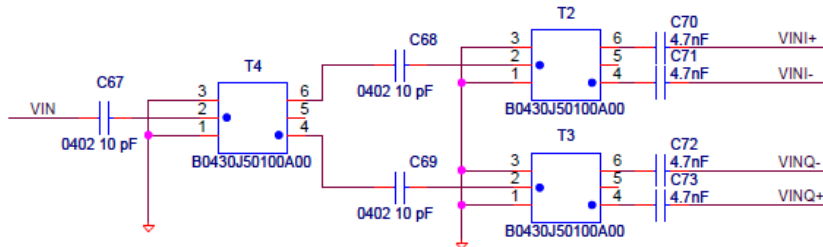
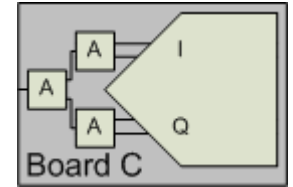


Key Features:

- Testing Non-DES, DESI, DESQ Modes
- One of each Multi-layer and wire-wound balun
- All routing accomplished in one layer
- Compact, balanced layout for best dynamic performance

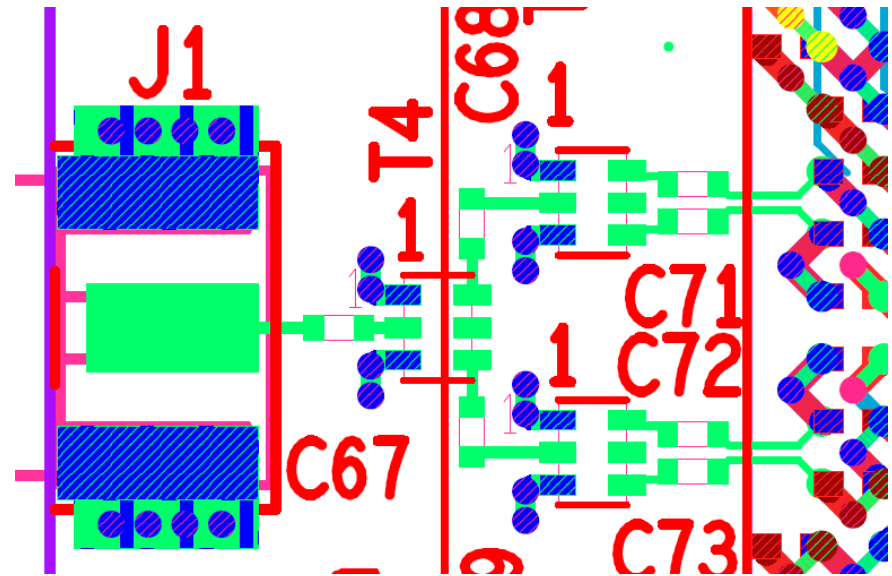


Board C: Cascaded Multi-layer balun to I- and Q-channel input

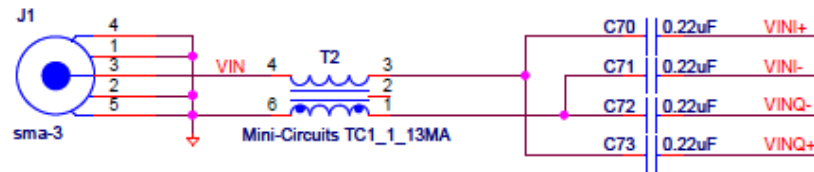
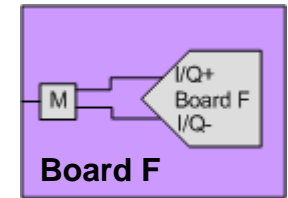


Key Features:

- Testing DESIQ, DESCLKIQ Modes
- Adding a selectable input to Pin 2 of T2 and Pin 2 of T3 can enable driving the part in DESI, DESQ, and Non-DES Modes, in addition to DESIQ Mode
- Cascaded Multi-layer balun design achieves impedance matching correct phase at each output, so that all routing may be accomplished in one layer

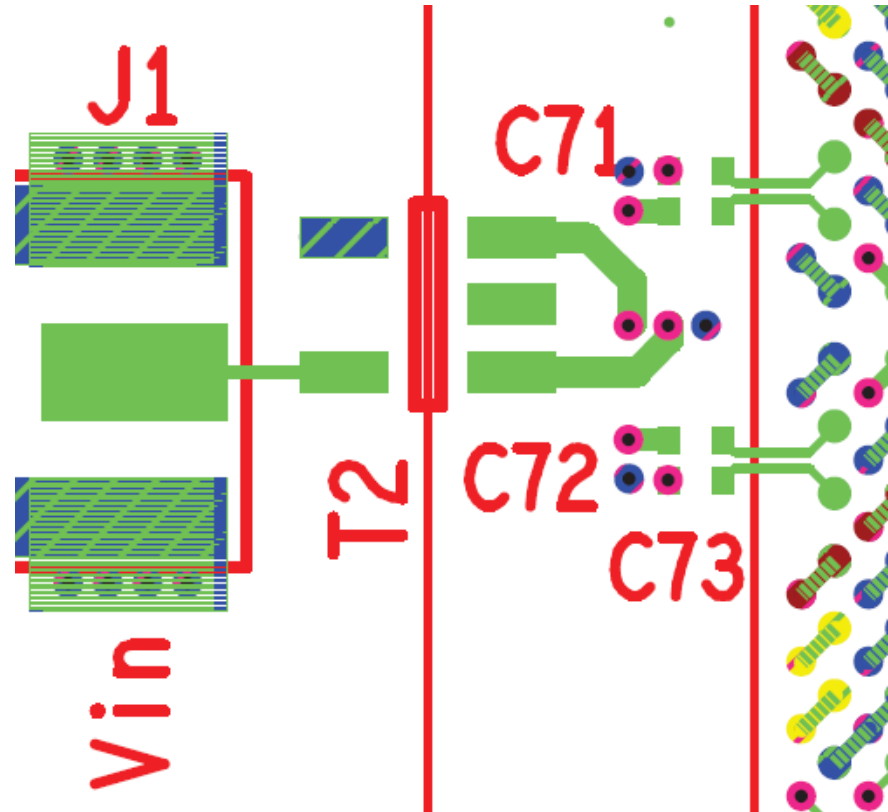


Board F: Wire-wound balun to I- and Q-channel input

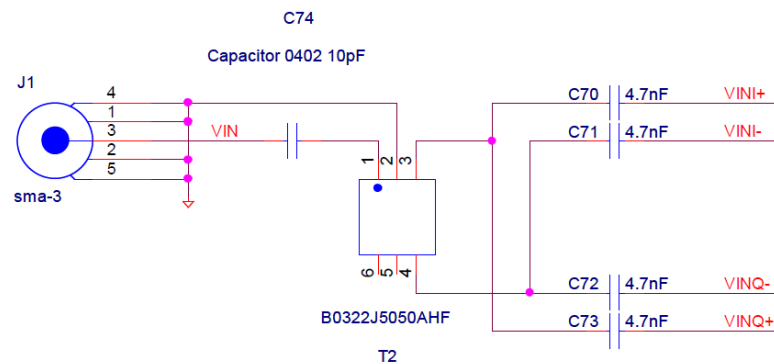
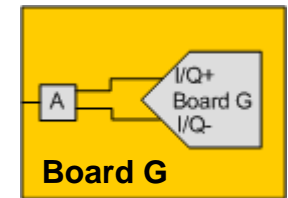


Key Features:

- Testing DESIQ and DESCLKIQ Modes
- Single wire-wound balun
- Routing in multiple layers
- Similar to TC1-DESIQ-SBB, external balun board for driving GSPS ADC reference boards

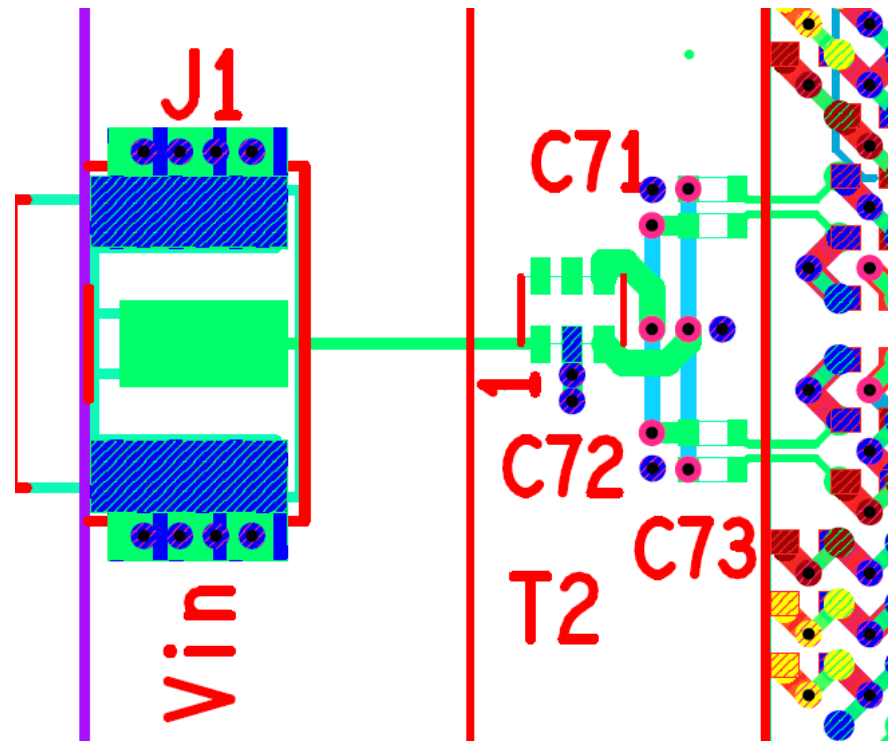


Board G: Multi-layer balun to I- and Q-channel input



Key Features:

- Testing DESIQ and DESCLKIQ Modes
- Single multi-layer balun
- Routing in multiple layers



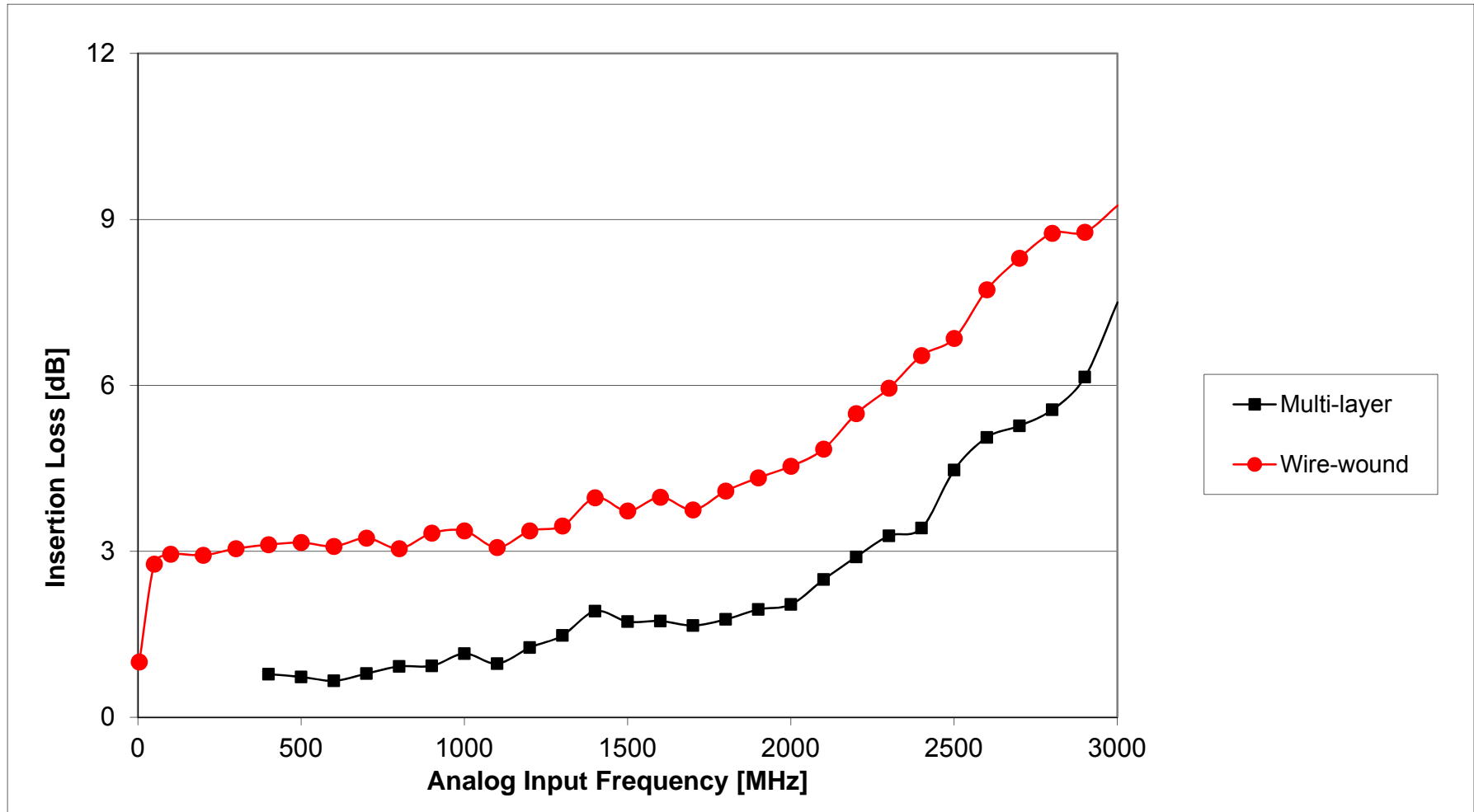
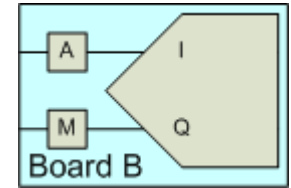
Non-DES Mode

DESI and DESQ Mode

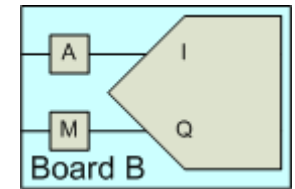
DESIQ and DESCLKIQ Mode

RESULTS SUMMARY

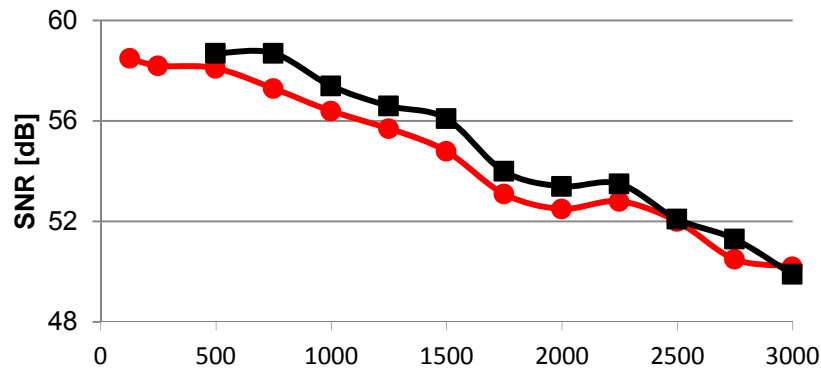
Non-DES Mode Insertion Loss



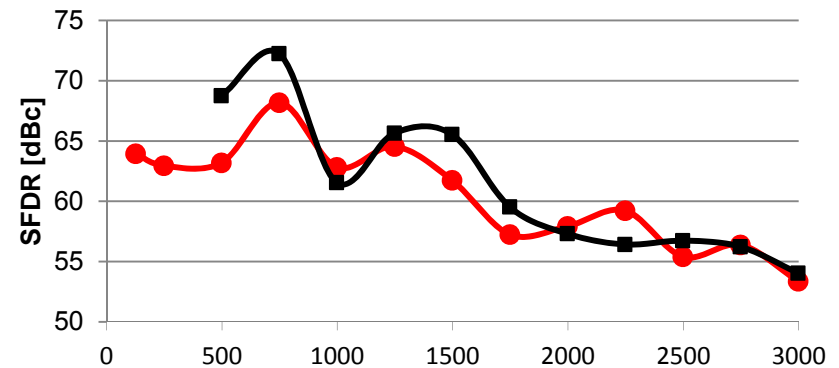
Non-DES Mode Dynamic Performance



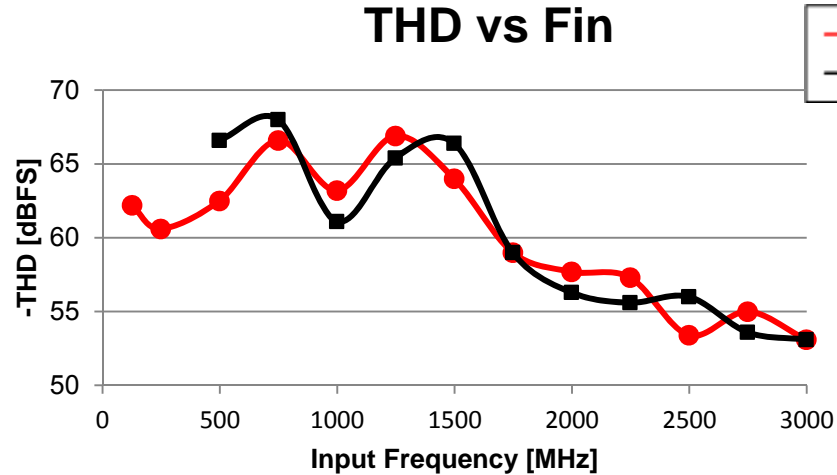
SNR vs Fin



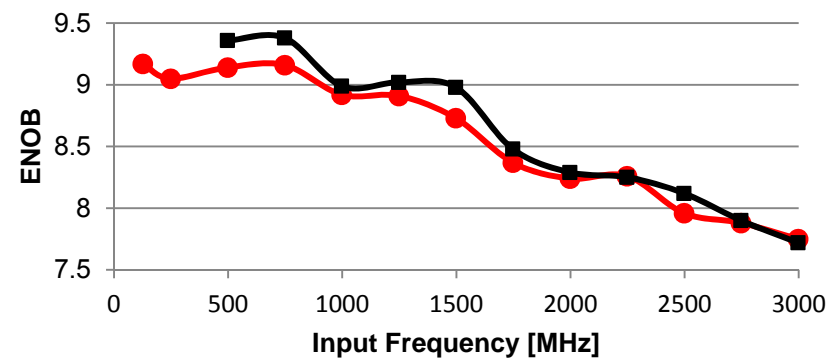
SFDR vs Fin



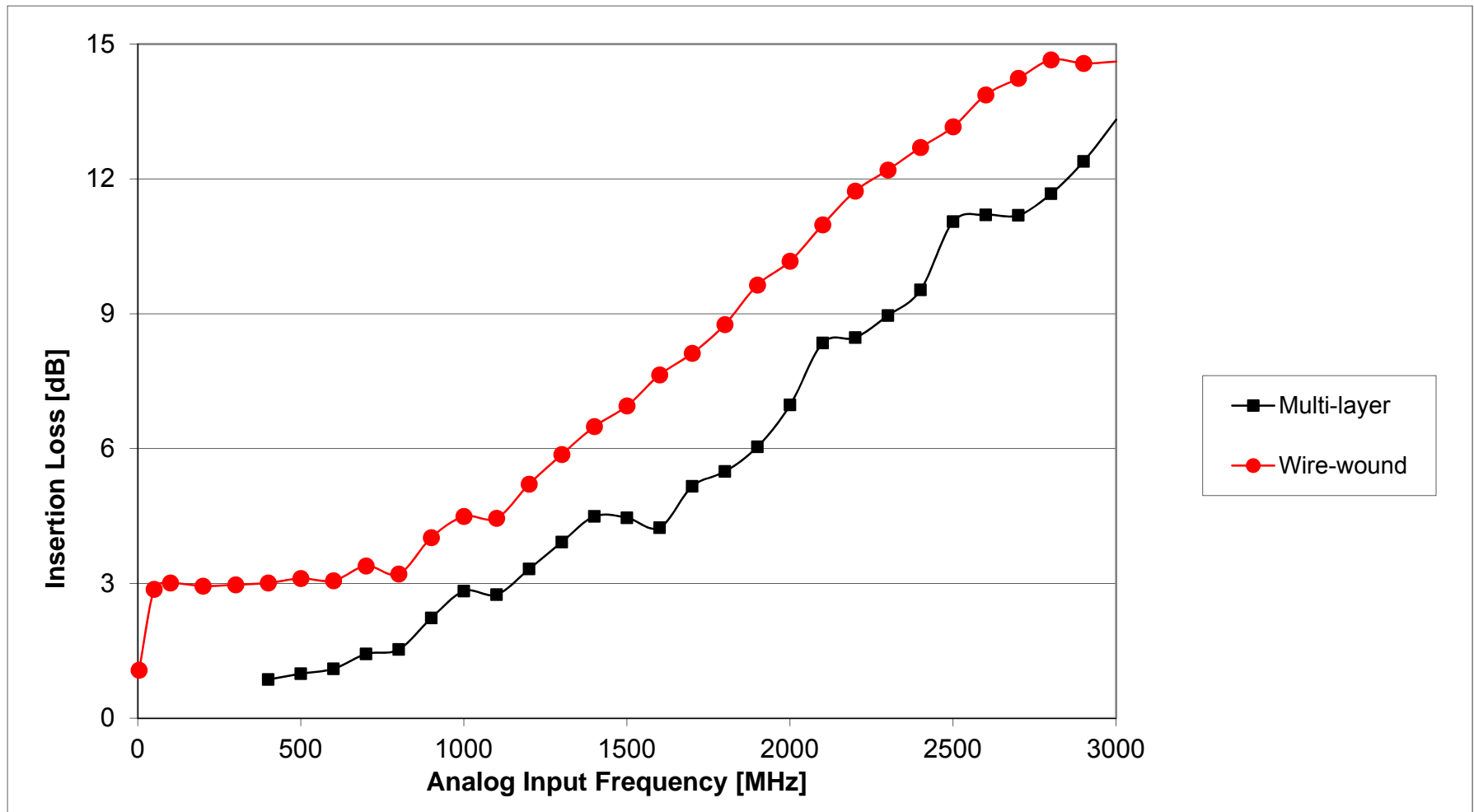
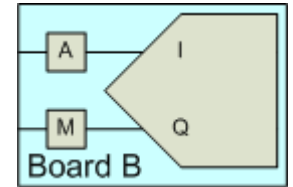
THD vs Fin



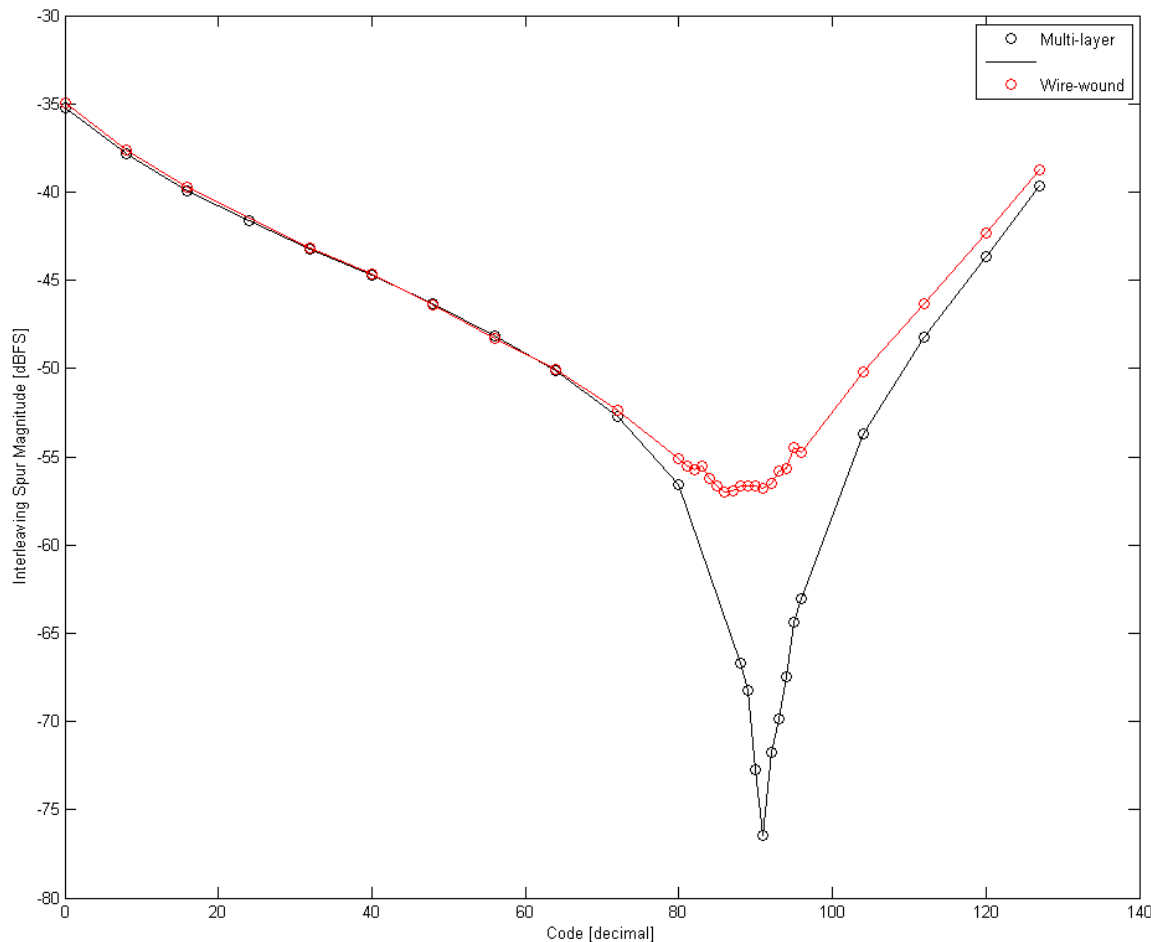
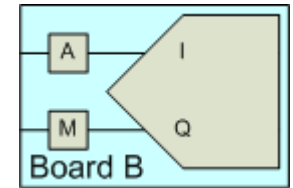
ENOB vs Fin



DESI & DESQ Mode Insertion Loss



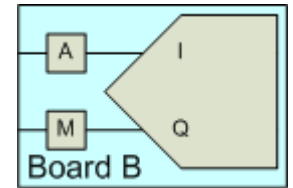
DESI & DESQ Mode DES Timing Adjust



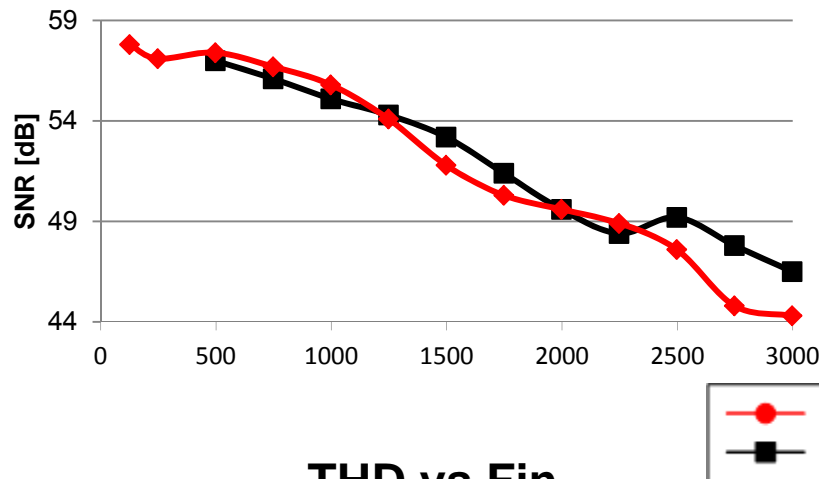
Balun	Unadjusted Gain Mismatch
Multi layer	0.14%
Wire wound	0.33%

- $F_{in} = 1300\text{MHz}$ @ -1dBFS
- Achieving a null in the interleaving spur is dependent upon I/Q-channel gain mismatch and timing skew.

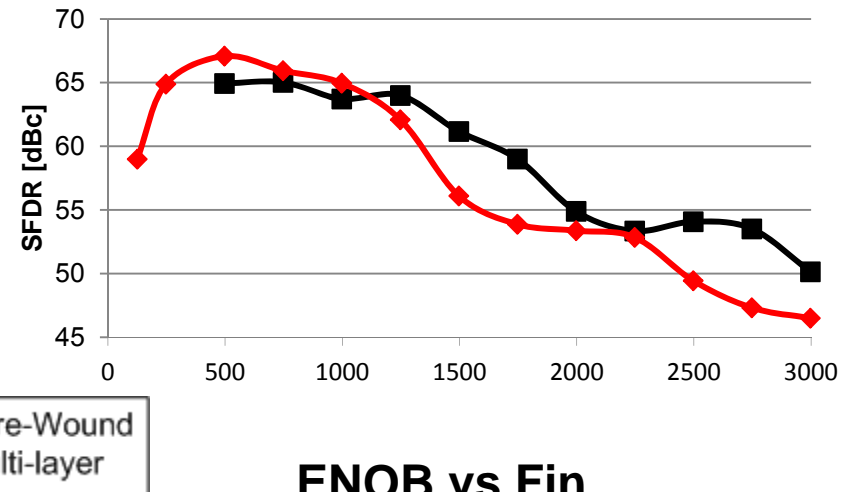
DESI & DESQ Mode Dynamic Performance



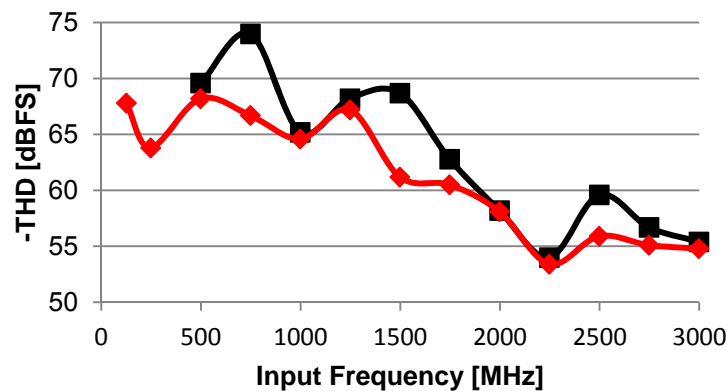
SNR vs Fin



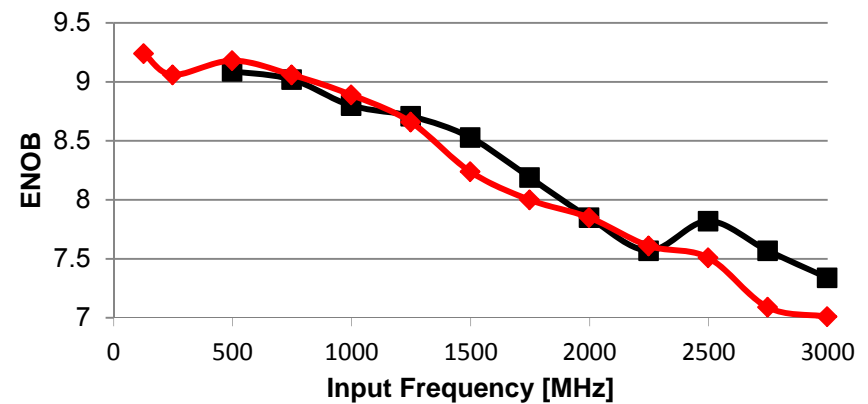
SFDR vs Fin



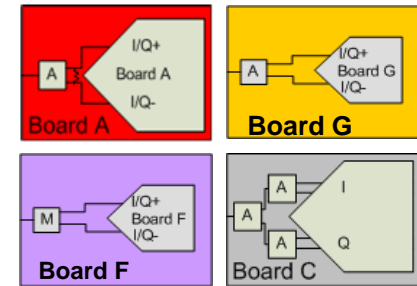
THD vs Fin



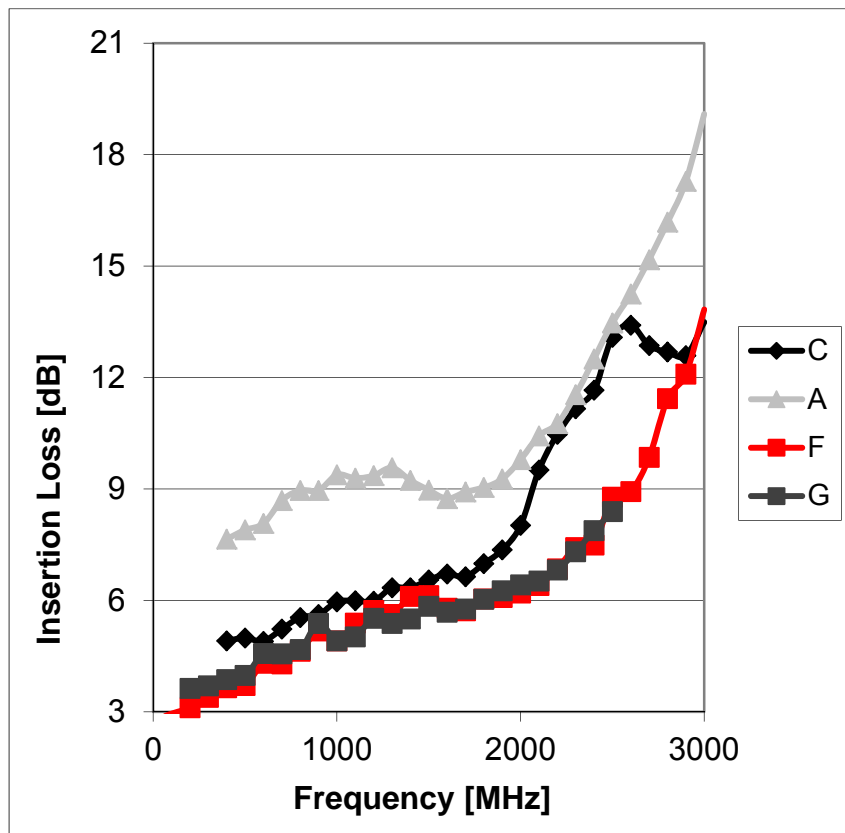
ENOB vs Fin



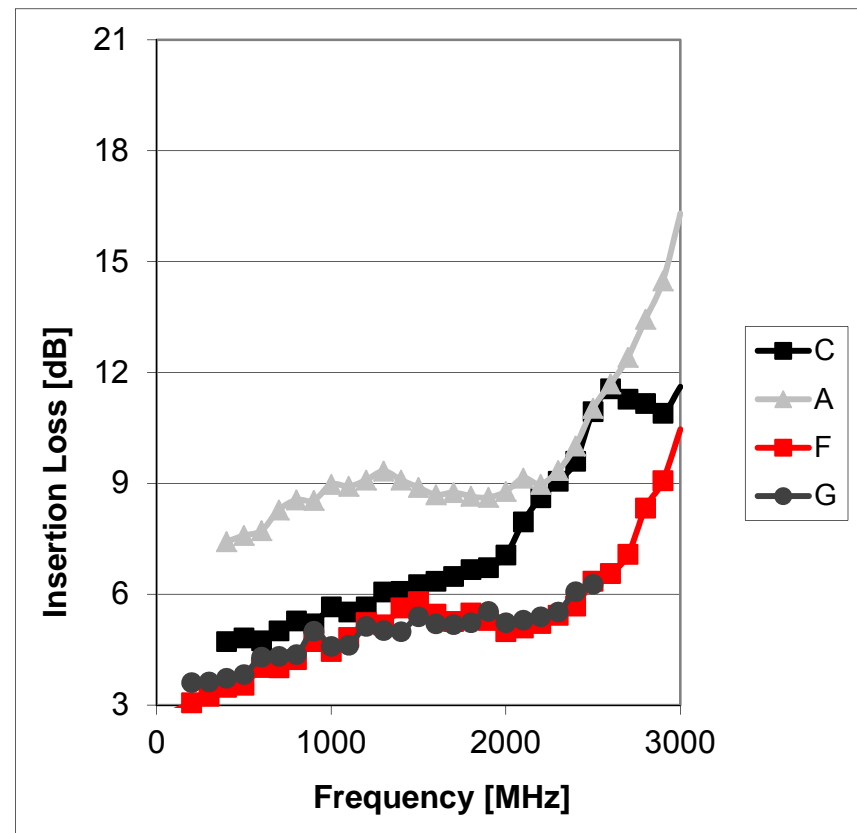
DESIQ and DESCLKIQ Mode Insertion Loss



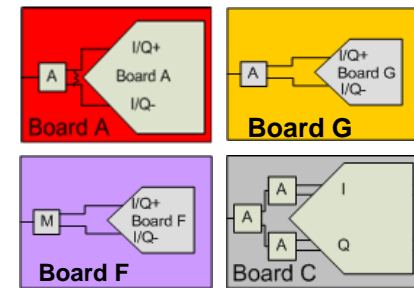
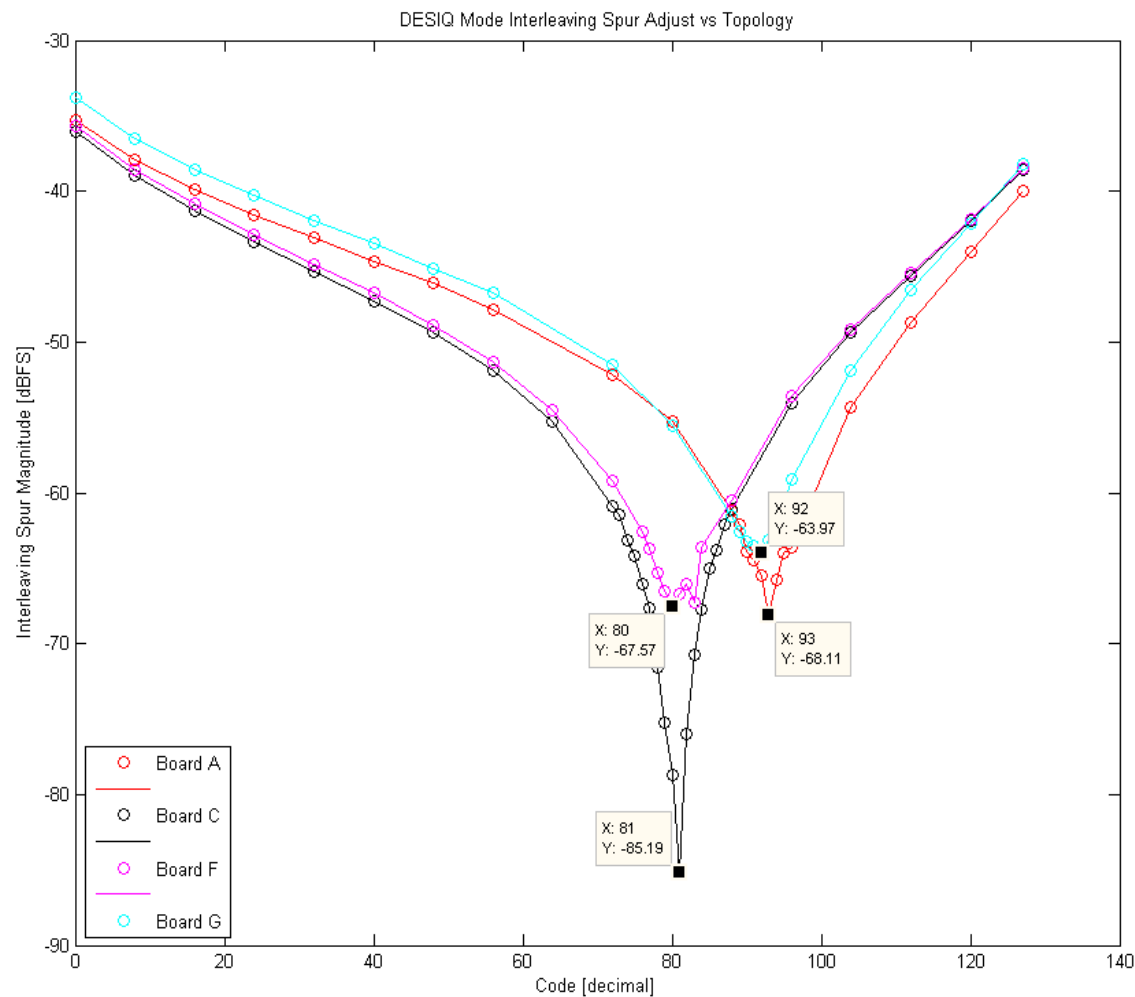
DESIQ Mode



DESCLKIQ Mode

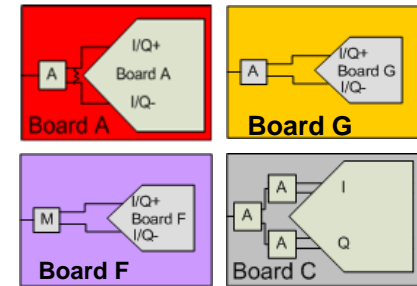
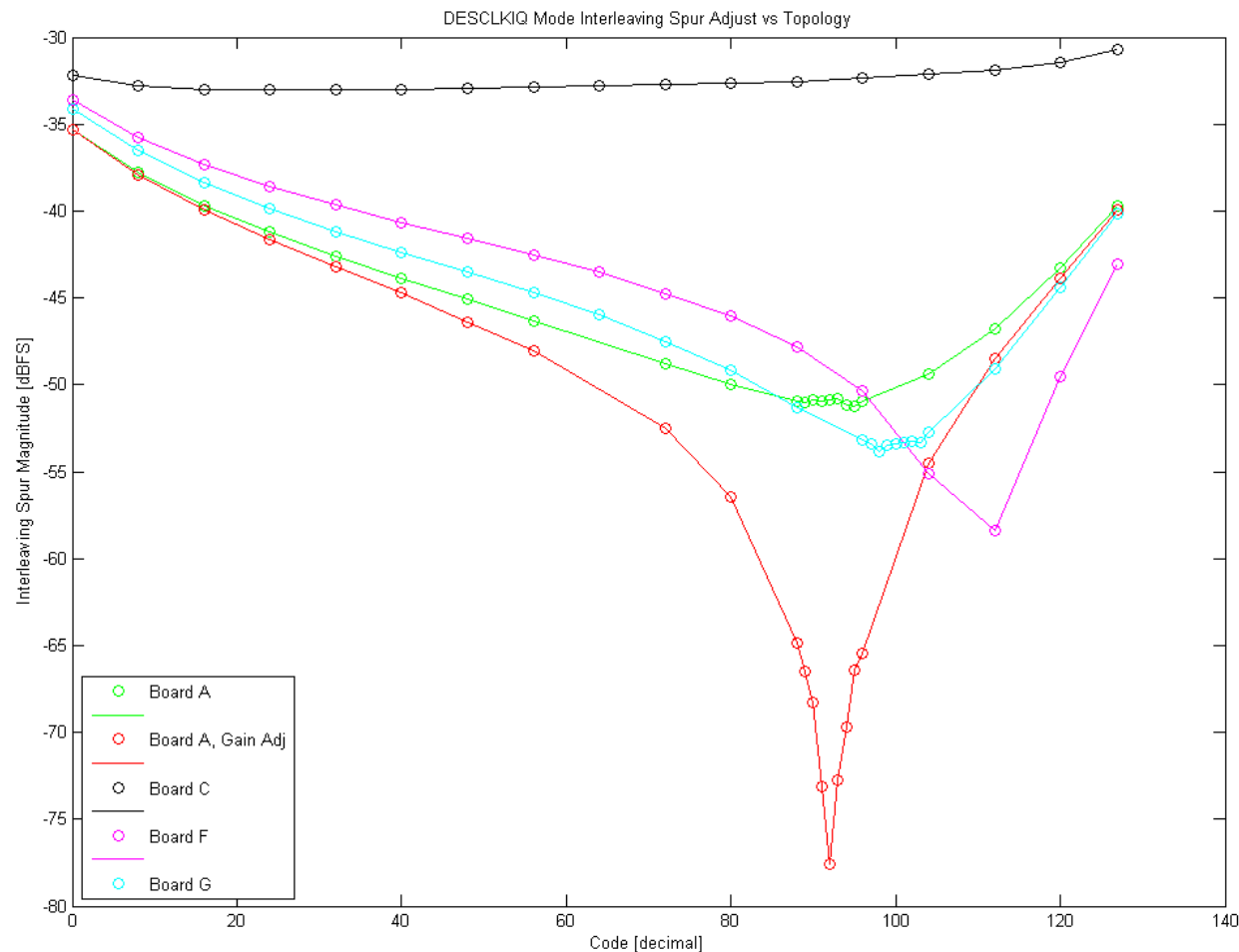


DESIQ Mode DES Timing Adjust



- DESIQ Mode allows for a relative minimum to be achieved relatively easily
- This is due to the internal connection which minimizes gain mismatch

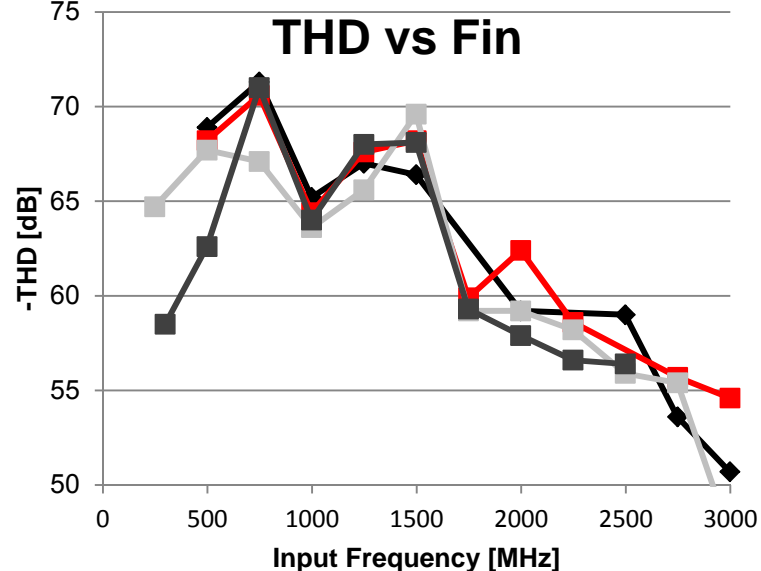
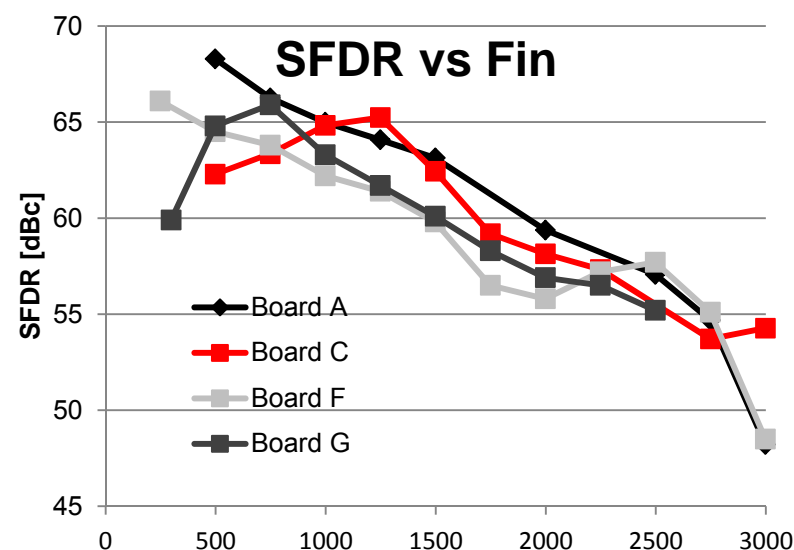
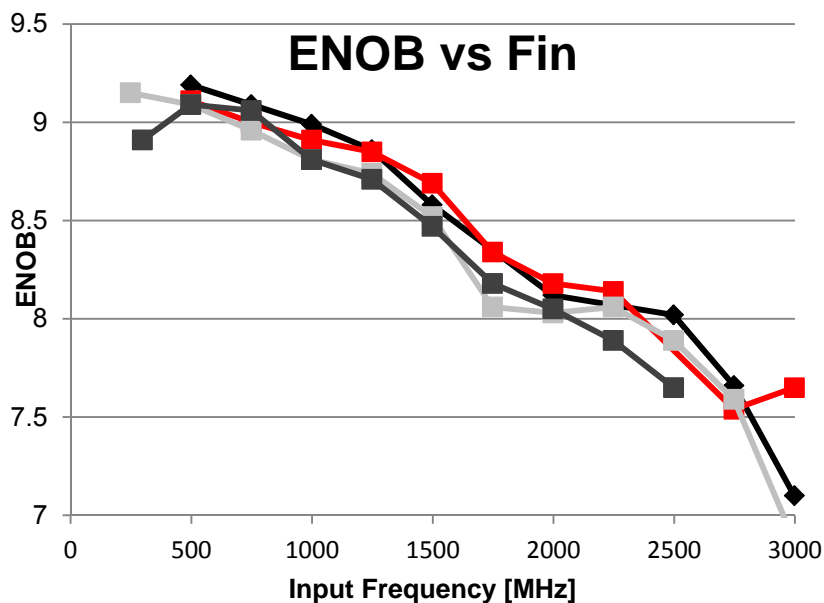
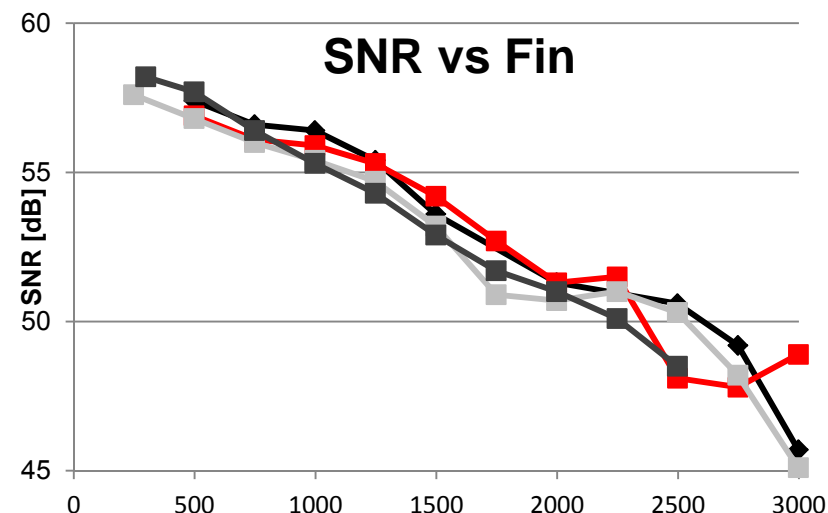
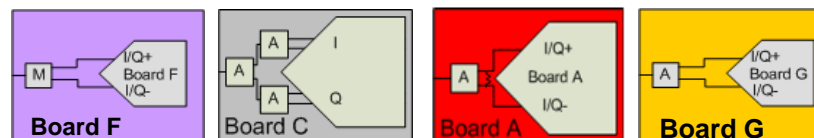
DESCLKIQ Mode DES Timing Adjust



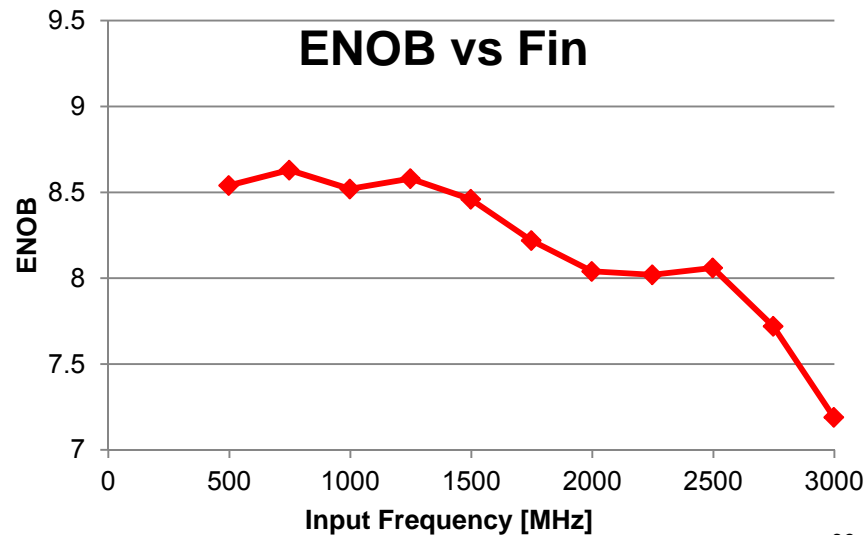
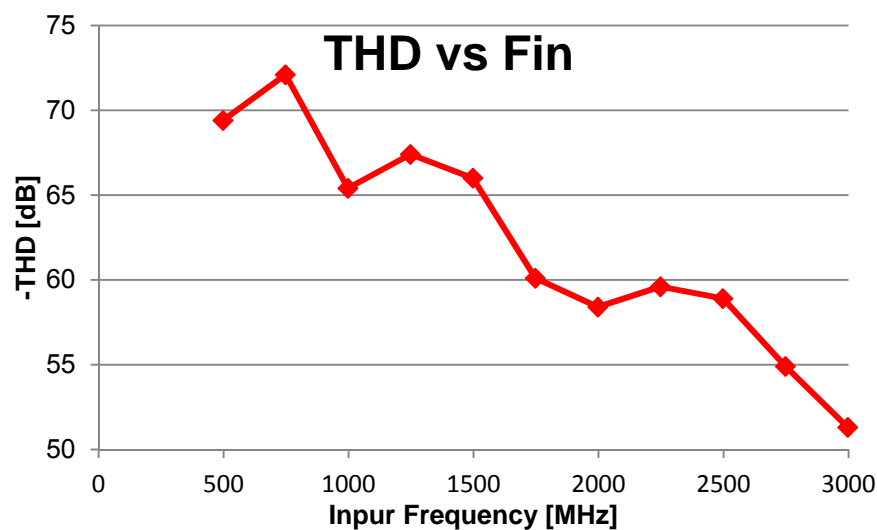
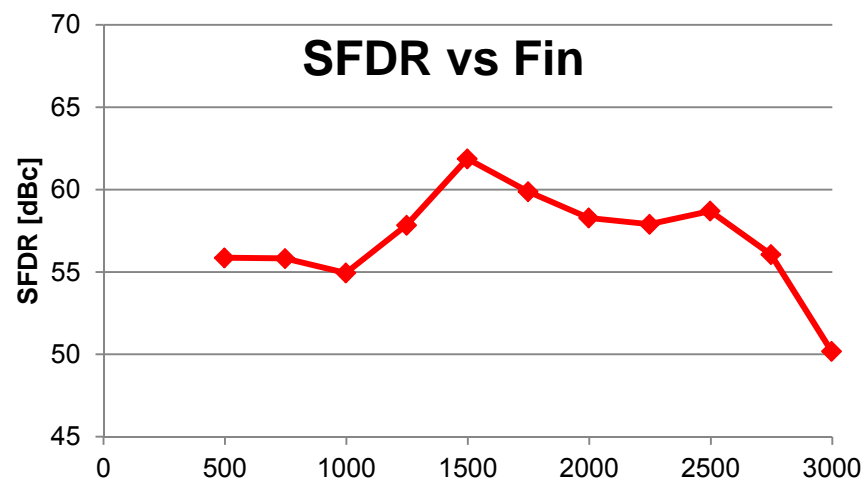
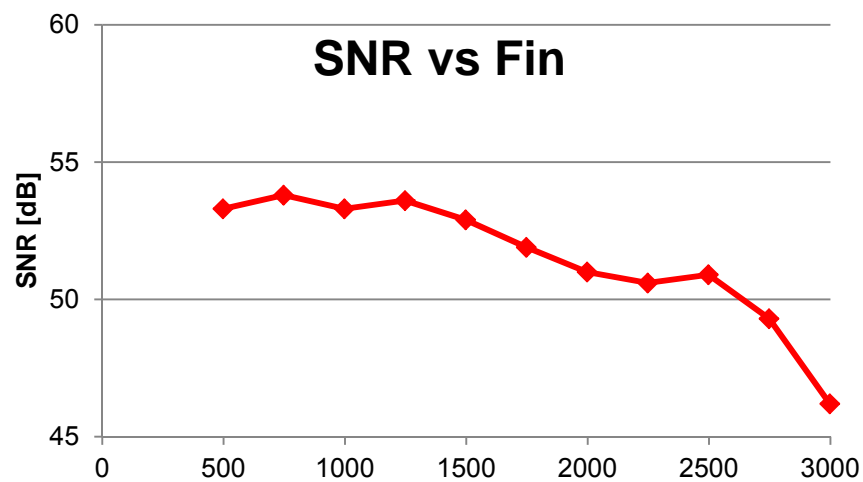
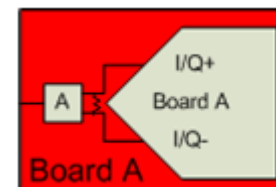
Board	Gain Adjust	Mis-match
A	No	5.4%
A	Yes	0.06%

- Timing skew and gain mismatch may be adjusted independently to achieve best performance

DESIQ Mode Dynamic Performance



DESCCLKIQ Mode Dynamic Performance



SUMMARY AND RECOMMENDATIONS

Non-DES Mode Summary

Criteria	Multi-layer	Wire-wound
Dynamic Performance	Excellent	Average
Insertion Loss	Excellent	Average
Frequency Range	Good	Excellent
Multi-mode Application	Average	Average

- The multi-layer balun excels in the areas of dynamic performance and insertion loss while the wire-wound balun is excellent for frequency range.
- Both baluns can easily drive both Non-DES Mode and DESI (or DESQ) Mode.

DESI and DESQ Mode Summary

Criteria	Multi-layer	Wire-wound
Dynamic Performance	Good	Average
Insertion Loss	Excellent	Average
Frequency Range	Good	Excellent
Multi-mode Application	Average	Average
Interleaving Spur Adjust	Excellent	Poor

- The multi-layer balun is a good all-round choice for multiple criteria.
- The wire-wound balun is excellent for frequency range, but poor for adjusting the interleaving spur.

DESIQ and DESCLKIQ Mode Summary

DESIQ Criteria	Board A	Board C	Board F	Board G
Dynamic Performance	Average	Good	Average	Good
Insertion Loss	Below Average	Average	Good	Excellent
Interleaving Spur Adjust	Average	Good	Average	Average
Multi-mode Application	Average	Excellent	Average	Average

DESCLKIQ Criteria	Board A	Board C	Board F	Board G
Dynamic Performance	Below Average	Not Recommended	Average	Average
Insertion Loss	Below Average	Good	Excellent	Excellent
Interleaving Spur Adjust	Good	Poor	Average	Average
Multi-mode Application	Average	Excellent	Average	Average

Solutions Recommendation



- **Non-DES Mode:** The multi-layer balun is the better solution for driving Non-DES Mode. This is true except for applications which require a large input frequency range, especially at low frequencies.
- **DESI and DESQ Mode:** Similarly, the multi-layer balun is better for driving DESI and DESQ Mode. It is also easier to adjust the DES timing spur using the multi-layer balun.
- **DESIQ and DESCLKIQ Mode:** In general, it is recommended to use DESIQ Mode instead of DESCLKIQ Mode because the timing spur is so difficult to adjust in DESCLKIQ Mode. The insertion loss is slightly better in DESCLKIQ Mode, but the DESIQ Mode insertion loss is quite comparable.

GPS ADC SOLUTIONS

ADC12D2000/1800/1600/1000/800/500RF

RF Sampling ADCs w/ Industry's Largest Nyquist Zone

Features

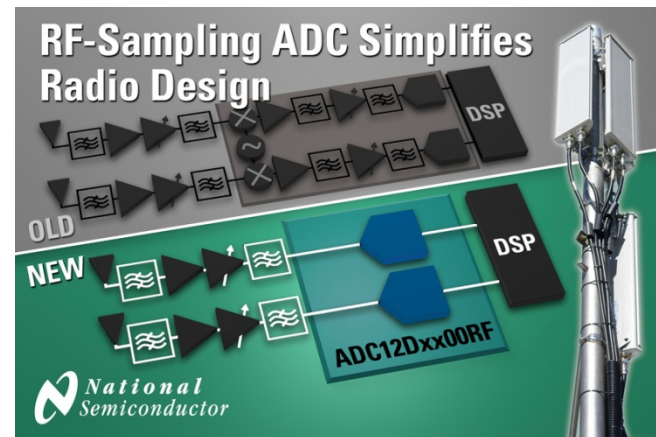
- Configurable:
 - 4.0/3.6/3.2/2.0/1.6/1.0 GSPS interleaved
 - 2.0/1.8/1.6/1.0/0.8/0.5 GSPS dual ADC
- **Excellent performance beyond 2.7 GHz**
- **Excellent performance beyond 11th Nyquist zone**
- **Noise floor:**
 - TBD/-155/-154.6/-154/-152.2/-150.5dBm/Hz
- **IMD3@2.7GHz:**
 - TBD/-64/-70/-69/-71/-69 dBFS
- **Power: 4.6/4.4/4.0/3.5/2.5/2.0W**
- Autosync function for multi-ADC applications*
- **Pin-compatible w/ ADC12D1x00 & ADC10D1x00**

Applications

- 3G/4G basestation receive & DPD
- Microwave backhaul
- RF-Sampling, wideband SDR
- T&M (scopes, data acquisition, analyzers)

Benefits

- **RF-Sampling capability replaces entire IF- and ZIF-sampling subsystems of mixers, LO synthesizers, filters, amplifiers, and ADCs**
- Industry's widest Nyquist zone of 2 GHz enables wideband software-defined radio (SDR) and allows combining multiple channels into one
- Reduction in board area, cost, and complexity
- Pin-compatible family allows range of resolution and speed-grade end-products



EVM: ADC12D2000RFRB, ADC12D1800RFRB, ADC12D1600RFRB, ADC12D800RFRB

*Not available on ADC12D2000RF

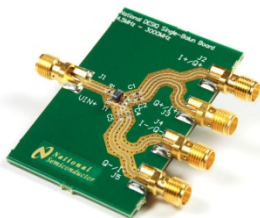
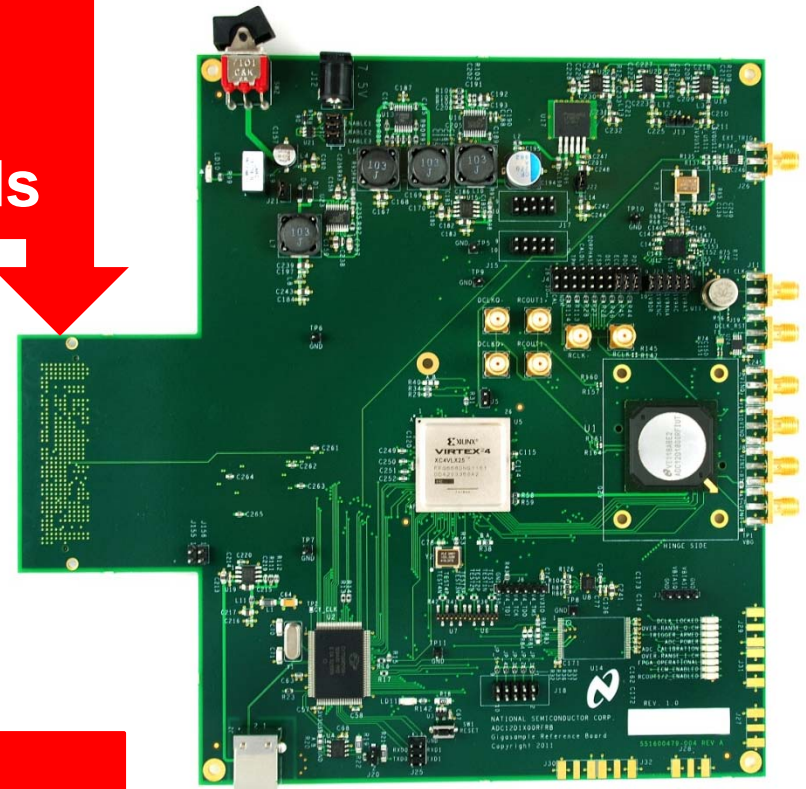
Evaluation Boards

ADC12D2000/1800/1600/1000RF

FMC Connector allows

- Full data rate streaming
- Connection to Xilinx dev boards

NSID	Eval Board
ADC12D1000RF	ADC12D1600RFRB
ADC12D1600RF	ADC12D1600RFRB
ADC12D1800RF	ADC12D1800RFRB
ADC12D2000RF	ADC12D2000RFRB



**Optional board for driving
DESIQ modes
NSID: TC1-DESIQ-SBB**

THANK YOU!